Multiple Moving Mask Deep X-Ray Lithography(M³DEXL) Process for 3-Dimensional Microstructure Fabrication

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ABSTRACT

An advanced technology using a multiple moving X-ray mask deep X-ray lithography (M^3DEXL) to realize various microstructures with inclined or free shape side wall, namely real 3-dimensional microstructures, was proposed. The side wall shape of a PMMA microstructure fabricated by deep X-ray lithography has been controlled by moving X-ray masks in parallel with the PMMA substrate during X-ray exposure. In order to demonstrate the feasibility of this M^3DEXL technology, various microstructures were successfully fabricated; (1) conical shape and truncated conical shape microstructures with height of 100 - 300 μ m and a diameter of 0 - 310 μ m and (2) grooves with saw shape cross section with depth of about 30 μ m and width of 100 - 150 μ m.

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